## **AMENDMENTS TO THE CLAIMS:**

The listing of claims shown below will replace all prior versions, and listings, of claims in the Application:

- 1. (Previously Presented) A method of forming MgB<sub>2</sub> films *in-situ* on a substrate comprising the steps:
- (a) depositing boron onto a surface of the substrate in a depressurized deposition zone;
- (b) moving the substrate into a reaction zone containing pressurized gaseous magnesium, the reaction zone being physically separate from the depressurized deposition zone and containing negligible amounts of oxygen;
  - (c) moving the substrate back into the deposition zone; and
  - (d) repeating steps (a)-(c).
- (Original) The method of claim 1, wherein the movement of steps (b) and(c) is produced by rotating the substrate on a platen.
- 3. (Original) The method of claim 2, wherein the platen is rotated at a rate within the range of about 100 rpm to about 500 rpm.
- 4. (Original) The method of claim 1, wherein the substrate is heated to a temperature within the range of about 300°C to about 700°C.

- 5. (Original) The method according to claim 1, wherein the substrate is selected from the group consisting of LSAT, LaAlO<sub>3</sub>, MgO, SrTiO<sub>3</sub>, r-plane sapphire, c-plane sapphire, m-plane sapphire, yttria-stabilized zirconia (YSZ), silicon carbide, polycrystalline alumina, silicon, and stainless steel.
- 6. (Previously Presented) The method of claim 1, wherein the reaction zone contains gaseous magnesium at a partial pressure of about 10 mTorr.
- 7. (Original) The method according to claim 1, wherein the reaction zone is coupled to a heated source of magnesium.
- 8. (Original) The method according to claim 1, wherein the substrate is a wafer.
- 9. (Original) The method according to claim 1, wherein the substrate is a tape.
- 10. (Original) The method according to claim 1, wherein the method is used to form  $MgB_2$  on a plurality of substrates.
- 11. (Previously Presented) The method of claim 1, wherein the boron is evaporated at a pressure of less than 10<sup>-6</sup> Torr in the deposition zone.

- 12. (Original) The method of claim 1, wherein the  $MgB_2$  film is formed on a single side of the substrate.
- 13. (Previously Presented) A method of forming MgB<sub>2</sub> films *in-situ* on a substrate comprising the steps:
  - (a) depositing boron onto a surface of the substrate in a deposition zone;
- (b) moving the substrate into a reaction zone containing pressurized gaseous magnesium;
  - (c) moving the substrate back into the deposition zone; and
  - (d) repeating steps (a)-(c);

wherein the MgB<sub>2</sub> film is formed on two sides of the substrate.

14. (Previously Presented) A method of forming a film of MgB<sub>2</sub> *in-situ* comprising the steps of:

providing a rotatable platen, the platen being rotatable within a housing having a pressurized reaction zone operatively coupled to an evaporation cell and a physically separate depressurized deposition zone, the pressurized reaction zone containing negligible amounts of oxygen;

providing magnesium in the evaporation cell;

providing a source of boron disposed adjacent to the depressurized deposition zone;

providing an electron beam gun aimed at the source of boron;

loading a substrate onto the platen;

rotating the platen;

heating the local environment around the substrate;

heating the evaporation cell so as to produce pressurized gaseous magnesium in the reaction zone; and

evaporating the boron with the electron beam gun.

- 15. (Original) The method according to claim 14, wherein the local environment around the substrate is heated to a temperature within the range of about 300°C to about 700°C.
- 16. (Original) The method according to claim 14, wherein the evaporation cell is heated to a temperature of at least 550°C.
- 17. (Original) The method according to claim 14, wherein the platen is rotated at a rate within the range of about 100 rpm to about 500 rpm.
- 18. (Original) The method according to claim 14, wherein the substrate is selected from the group consisting of LSAT, LaAlO<sub>3</sub>, MgO, SrTiO<sub>3</sub>, r-plane sapphire, c-plane sapphire, m-plane sapphire, yttria-stabilized zirconia (YSZ), silicon carbide, polycrystalline alumina, silicon, and stainless steel.
  - 19. (Original) The method of claim 14, wherein the substrate is a wafer.
  - 20. (Original) The method of claim 14, wherein the substrate is a tape.

- 21. (Original) The method of claim 14, wherein the step of loading the platen comprises loading the platen with a plurality of substrates.
- 22. (Previously Presented) The method of claim 14, wherein the boron is evaporated at a pressure of less than 10<sup>-6</sup> Torr in the deposition zone.
- 23. (Original) The method of claim 14, wherein a film of MgB<sub>2</sub> is formed on a single side of the substrate.
- 24. (Previously Presented) A method of forming a film of MgB<sub>2</sub> *in-situ* comprising the steps of:

providing a rotatable platen, the platen being rotatable within a housing having a reaction zone and a separate deposition zone;

providing an evaporation cell operatively coupled to the reaction zone, the evaporation cell containing magnesium;

providing a source of boron disposed adjacent to the deposition zone;

providing an electron beam gun aimed at the source of boron;

loading a substrate onto the platen;

rotating the platen;

heating the local environment around the substrate;

heating the evaporation cell so as to produce gaseous magnesium in the reaction zone;

evaporating the boron with the electron beam gun;

removing the substrate from the platen;

turning the substrate over;

loading the substrate onto the platen;

rotating the platen:

heating the local environment around the substrate;

heating the evaporation cell so as to produce pressurized gaseous magnesium in the reaction zone; and

evaporating the boron with the electron beam gun.

- 25. (Previously Presented) The method of claim 14, wherein the reaction zone contains gaseous magnesium at a partial pressure of about 10 mTorr.
- 26. (Currently Amended) A method of forming a thin film of a known eempound magnesium diboride *in-situ* on a substrate comprising:
- (a) depositing one or more elements of the compound boron onto a surface of the substrate in a depressurized deposition zone;
- (b) heating a metallic element of the compound magnesium so as to produce a pressurized gaseous phase of magnesium the metallic element inside a reaction zone, the reaction zone being physically separate from the depressurized deposition zone and containing negligible amounts of oxygen;
- (c) moving the substrate into the reaction zone containing the pressurized magnesium metallic element;

- (d) moving the substrate back into the depressurized deposition zone; and
- (e) repeating steps (a)-(d).
- 27.-32. (Cancelled)